

CD4017BC • CD4022BC

Decade Counter/Divider with 10 Decoded Outputs • Divide-by-8 Counter/Divider with 8 Decoded Outputs

General Description

The CD4017BC is a 5-stage divide-by-10 Johnson counter with 10 decoded outputs and a carry out bit.

The CD4022BC is a 4-stage divide-by-8 Johnson counter with 8 decoded outputs and a carry-out bit.

These counters are cleared to their zero count by a logical "1" on their reset line. These counters are advanced on the positive edge of the clock signal when the clock enable signal is in the logical "0" state.

The configuration of the CD4017BC and CD4022BC permits medium speed operation and assures a hazard free counting sequence. The 10/8 decoded outputs are normally in the logical "0" state and go to the logical "1" state only at their respective time slot. Each decoded output remains high for 1 full clock cycle. The carry-out signal completes a full cycle for every 10/8 clock input cycles and is used as a ripple carry signal to any succeeding stages.

Features

- Wide supply voltage range: 3.0V to 15V
- High noise immunity: 0.45 V_{DD} (typ.)
- Low power Fan out of 2 driving 74L TTL compatibility: or 1 driving 74LS
- Medium speed operation: 5.0 MHz (typ.) with 10V V_{DD}
- Low power: 10 μ W (typ.)
- Fully static operation

Applications

- Automotive
- Instrumentation
- Medical electronics
- Alarm systems
- Industrial electronics
- Remote metering

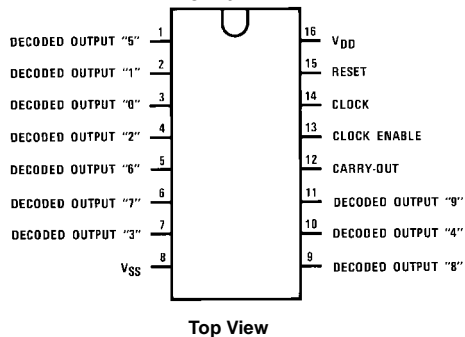
Ordering Code:

Order Number	Package Number	Package Description
CD4017BCM	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
CD4017BCSJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
CD4017BCN	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
CD4022BCM	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
CD4022BCN	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

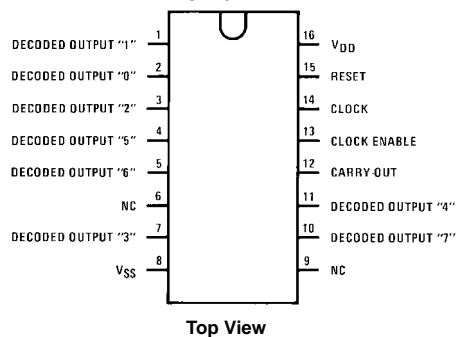
Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagrams

Pin Assignments for DIP, SOIC and SOP
CD4017B



Pin Assignments for DIP and SOIC
CD4022B



Absolute Maximum Ratings (Note 1)

(Note 2)

DC Supply Voltage (V_{DD})	-0.5 V_{DC} to +18 V_{DC}
Input Voltage (V_{IN})	-0.5 V_{DC} to V_{DD} +0.5 V_{DC}
Storage Temperature (T_S)	-65°C to +150°C
Power Dissipation (P_D)	
Dual-In-Line	700 mW
Small Outline	500 mW
Lead Temperature (T_L)	
(Soldering, 10 seconds)	260°C

Recommended Operating Conditions (Note 2)

DC Supply Voltage (V_{DD})	+3 V_{DC} to +15 V_{DC}
Input Voltage (V_{IN})	0 to V_{DD} V_{DC}
Operating Temperature Range (T_A)	-55°C to +125°C

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed, they are not meant to imply that the devices should be operated at these limits. The table of "Recommended Operating Conditions" and "Electrical Characteristics" provides conditions for actual device operation.

Note 2: $V_{SS} = 0V$ unless otherwise specified.

DC Electrical Characteristics (Note 2)

Symbol	Parameter	Conditions	-55°C		+25°			+125°C		Units
			Min	Max	Min	Typ	Max	Min	Max	
I_{DD}	Quiescent Device Current	$V_{DD} = 5V$		5		0.3	5		150	μA
		$V_{DD} = 10V$		10		0.5	10		300	
		$V_{DD} = 15V$		20		1.0	20		600	
V_{OL}	LOW Level Output Voltage	$ I_{OL} < 1.0 \mu A$								V
		$V_{DD} = 5V$		0.05		0	0.05		0.05	
		$V_{DD} = 10V$		0.05		0	0.05		0.05	
		$V_{DD} = 15V$		0.05		0	0.05		0.05	
V_{OH}	HIGH Level Output Voltage	$ I_{OL} < 1.0 \mu A$								V
		$V_{DD} = 5V$	4.95		4.95	5		4.95		
		$V_{DD} = 10V$	9.95		9.95	10		9.95		
		$V_{DD} = 15V$	14.95		14.95	15		14.95		
V_{IL}	LOW Level Input Voltage	$ I_{OL} < 1.0 \mu A$								V
		$V_{DD} = 5V, V_O = 0.5V$ or $4.5V$		1.5			1.5		1.5	
		$V_{DD} = 10V, V_O = 1.0V$ or $9.0V$		3.0			3.0		3.0	
		$V_{DD} = 15V, V_O = 1.5V$ or $13.5V$		4.0			4.0		4.0	
V_{IH}	HIGH Level Input Voltage	$ I_{OL} < 1.0 \mu A$								V
		$V_{DD} = 5V, V_O = 0.5V$ or $4.5V$	3.5		3.5			3.5		
		$V_{DD} = 10V, V_O = 1.0V$ or $9.0V$	7.0		7.0			7.0		
		$V_{DD} = 15V, V_O = 1.5V$ or $13.5V$	11.0		11.0			11.0		
I_{OL}	LOW Level Output Current (Note 3)	$V_{DD} = 5V, V_O = 0.4V$	0.64		0.51	0.88		0.36		mA
		$V_{DD} = 10V, V_O = 0.5V$	1.6		1.3	2.25		0.9		
		$V_{DD} = 15V, V_O = 1.5V$	4.2		3.4	8.8		2.4		
I_{OH}	HIGH Level Output Current (Note 3)	$V_{DD} = 5V, V_O = 4.6V$	-0.25		-0.2	-0.36		-0.14		mA
		$V_{DD} = 10V, V_O = 9.5V$	-0.62		-0.5	-0.9		-0.35		
		$V_{DD} = 15V, V_O = 13.5V$	-1.8		-1.5	-3.5		-1.1		
I_{IN}	Input Current	$V_{DD} = 15V, V_{IN} = 0V$		-0.1		-10^{-5}	-0.1		-1.0	μA
		$V_{DD} = 15V, V_{IN} = 15V$		0.1		10^{-5}	0.1		1.0	

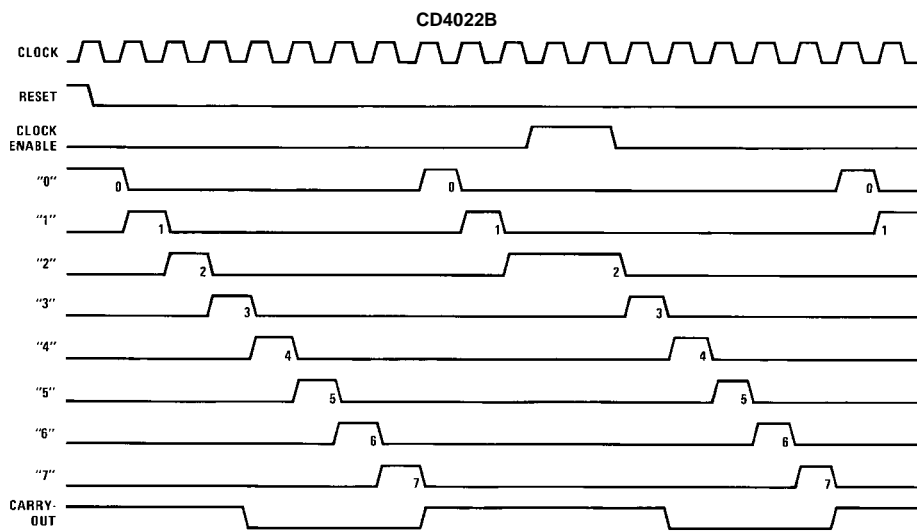
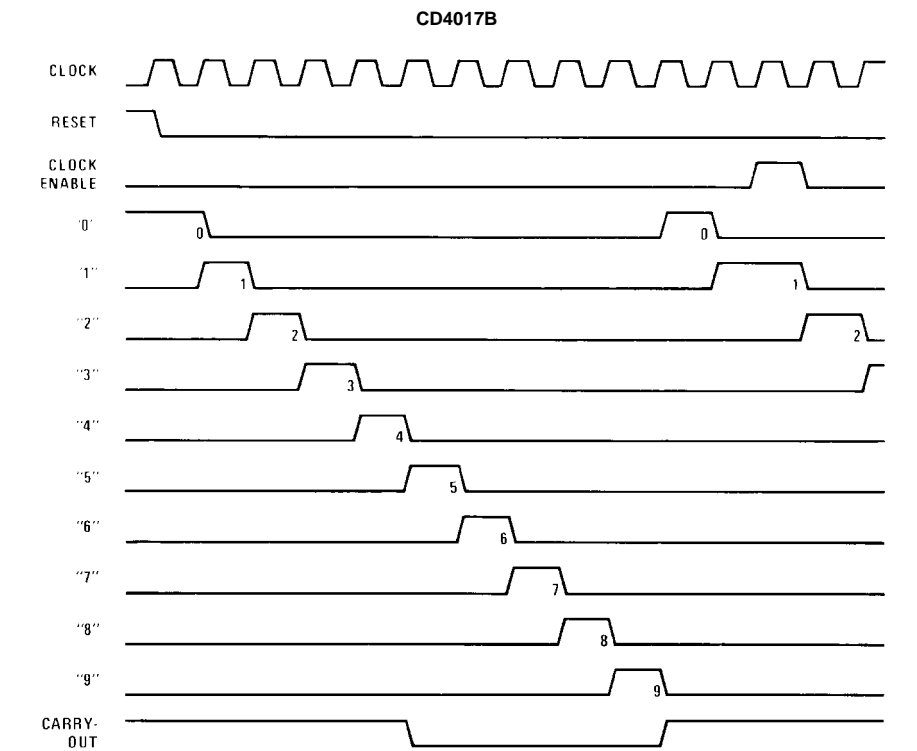
Note 3: I_{OL} and I_{OH} are tested one output at a time.

AC Electrical Characteristics (Note 4)						
T _A = 25°C, C _L = 50 pF, R _L = 200k, t _{rCL} and t _{fCL} = 20 ns, unless otherwise specified						
Symbol	Parameter	Conditions	Min	Typ	Max	Units
CLOCK OPERATION						
t _{PHL} , t _{PLH}	Propagation Delay Time Carry Out Line	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V		415 160 130	800 320 250	ns
	Carry Out Line	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V	C _L = 15 pF	240 85 70	480 170 140	ns
	Decode Out Lines	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V		500 200 160	1000 400 320	ns
t _{TLH} , t _{THL}	Transition Time Carry Out and Decode Out Lines					
	t _{TLH}	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V		200 100 80	360 180 130	ns
	t _{THL}	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V		100 50 40	200 100 80	ns
f _{CL}	Maximum Clock Frequency	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V	Measured with Respect to Carry Output Line	1.0 2.5 3.0	2 5 6	MHz
t _{WL} , t _{WH}	Minimum Clock Pulse Width	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V		125 45 35	250 90 70	ns
t _{rCL} , t _{fCL}	Clock Rise and Fall Time	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V			20 15 5	μs
t _{SU}	Minimum Clock Inhibit Data Setup Time	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V		120 40 32	240 80 65	ns
C _{IN}	Average Input Capacitance			5	7.5	pF

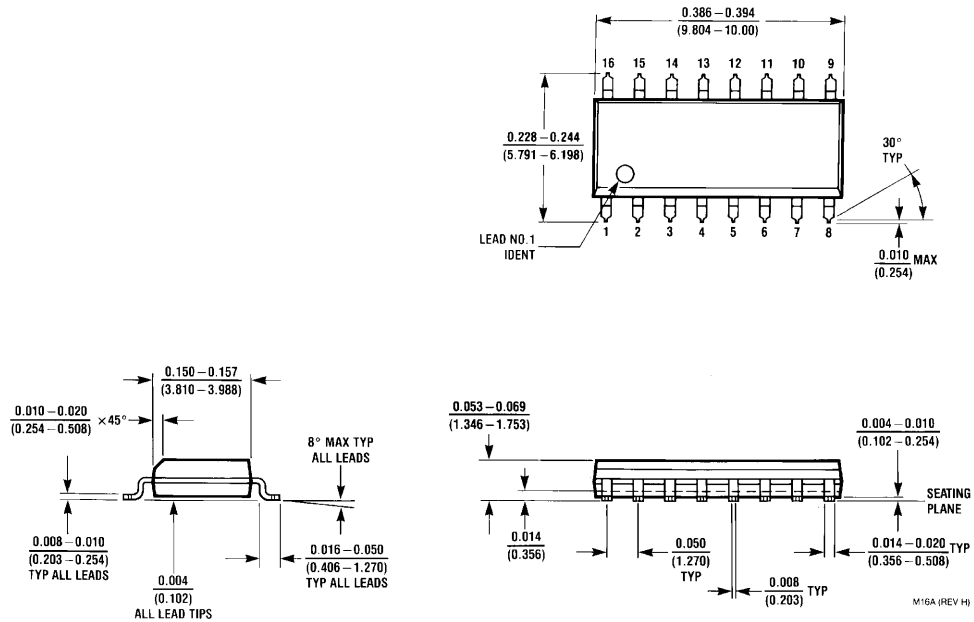
Note 4: AC Parameters are guaranteed by DC correlated testing.

AC Electrical Characteristics (Note 4)						
T _A = 25°C, C _L = 50 pF, R _L = 200k, t _{rCL} and t _{fCL} = 20 ns, unless otherwise specified						
Symbol	Parameter	Conditions	Min	Typ	Max	Units
RESET OPERATION						
t _{PHL} , t _{PLH}	Propagation Delay Time Carry Out Line	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V		415 160 130	800 320 250	ns
	Carry Out Line	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V	C _L = 15 pF	240 85 70	480 170 140	ns
	Decode Out Lines	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V		500 200 160	1000 400 320	ns
t _W	Minimum Reset Pulse Width	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V		200 70 55	400 140 110	ns
t _{REM}	Minimum Reset Removal Time	V _{DD} = 5V V _{DD} = 10V V _{DD} = 15V		75 30 25	150 60 50	ns

Timing Diagrams



Physical Dimensions inches (millimeters) unless otherwise noted

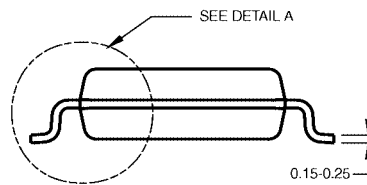
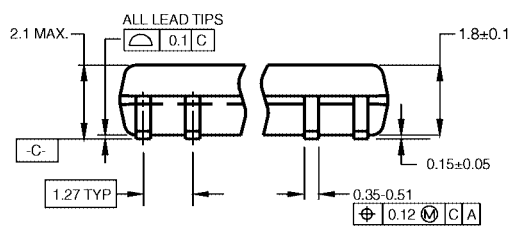


16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M16A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



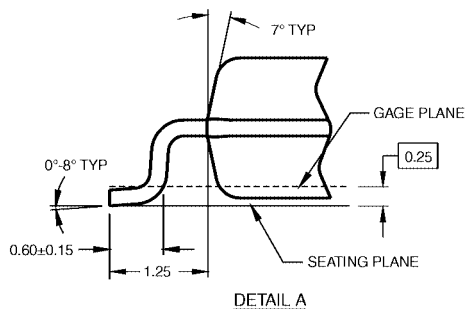
LAND PATTERN RECOMMENDATION



DIMENSIONS ARE IN MILLIMETERS

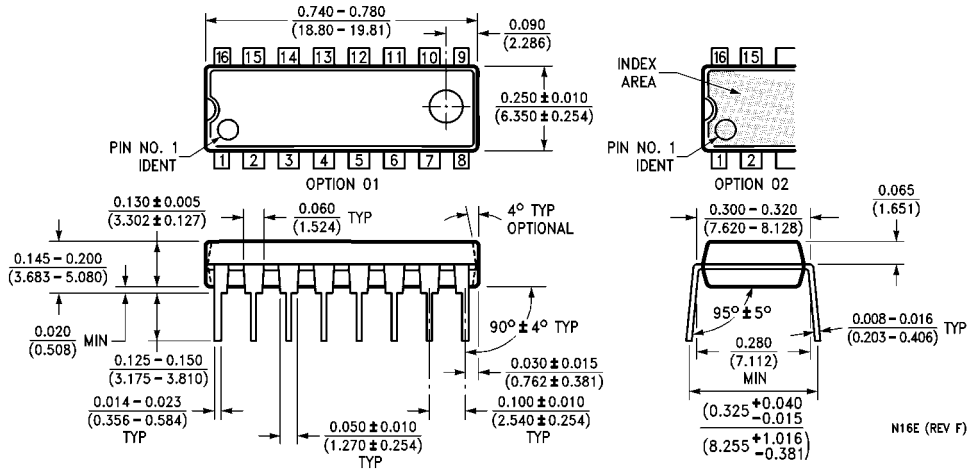
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 A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
 B. DIMENSIONS ARE IN MILLIMETERS.
 C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M16DRevB1



**16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
 Package Number M16D**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N16E

N16E (REV F)

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